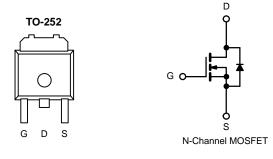


N-Channel 150 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)			
150	0.074 at V_{GS} = 10 V	25.4	23 nC			
150	0.077 at V _{GS} = 8 V	22.5	23110			



FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- Extremely Low Q_{gd} for Switching Losses
- 100 % Rg Tested
- 100 % Avalanche Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Primary Side Switch



HALOGEN

FREE

Available

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	150	V		
Gate-Source Voltage		V _{GS}		± 20	
	T _C = 25 °C		25.4		
Continuous Drain Current (T 150 °C)	T _C = 70 °C		23.1		
Continuous Drain Current ($T_J = 150 \ ^{\circ}C$)	T _A = 25 °C	I _D	15.5 ^{b, c}		
	T _A = 70 °C		14.5 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	50	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		4.5		
Continuous Source-Drain Diode Current	T _A = 25 °C	ا _S	2.6 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	20		
Single Pulse Avalanche Energy	L = 0.1 mm	E _{AS}	20	mJ	
	T _C = 25 °C		5.9		
Maximum Rower Dissinction	T _C = 70 °C		3.8	w	
Maximum Power Dissipation	T _A = 25 °C	P _D	3.1 ^{b, c}	VV	
	T _A = 70 °C		2 ^{b, c}		
Operating Junction and Storage Temperature Range		T _J , T _{stq}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
	Symbol	Typical	Maximum	Unit			
t ≤ 10 s	R _{thJA}	33	40	°C/W			
Steady State	R _{thJF}	17	21				
	t ≤ 10 s	Symbol t ≤ 10 s R _{thJA}	Symbol Typical t ≤ 10 s R _{thJA} 33	Symbol Typical Maximum t ≤ 10 s R _{thJA} 33 40			

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 80 °C/W.

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	•					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	150			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			172		
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 10		mV/°C
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.5		3.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zana Casta Maltana Duain Current		$V_{DS} = 150 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	
Zero Gate Voltage Drain Current	DSS	V _{DS} = 120 V, V _{GS} = 0 V, T _J = 55 °C	$\begin{array}{c c} S \geq 10 \text{ V}, \text{ V}_{\text{GS}} = 10 \text{ V} & 30 \\ \hline \\ S \equiv 10 \text{ V}, \text{ I}_{\text{D}} = 5 \text{ A} & 0.0 \\ \hline \\ S \equiv 8 \text{ V}, \text{ I}_{\text{D}} = 5 \text{ A} & 0.0 \\ \hline \\ S \equiv 15 \text{ V}, \text{ I}_{\text{D}} = 5 \text{ A} & 22 \\ \hline \\ O \text{ V}, \text{ V}_{\text{GS}} = 0 \text{ V}, \text{ f} = 1 \text{ MHz} & 1 \\ \hline \\ \hline \end{array}$		10	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30			A
Drain Source On State Desistenced		$V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		0.074		Ω
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 8 V, I_{D} = 5 A$		0.077		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 5 \text{ A}$		23		S
Dynamic ^b			·			
Input Capacitance	C _{iss}			1735		pF
Output Capacitance	C _{oss}	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		160		
Reverse Transfer Capacitance	C _{rss}			37		
Total Cata Charge		$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 5 \text{ A}$		28.5	43	nC
Total Gate Charge	Qg			23	35	
Gate-Source Charge	Q _{gs}	V_{DS} = 75 V, V_{GS} = 8 V, I_{D} = 5 A		8		
Gate-Drain Charge	Q _{gd}			6.5		
Gate Resistance	R _g	f = 1 MHz		0.85	1.3	Ω
Turn-on Delay Time	t _{d(on)}			14	21	
Rise Time	t _r	V_{DD} = 50 V, R_L = 10 Ω		12	18	- ns
Turn-Off Delay Time	t _{d(off)}	${ m I}_{ m D}\cong$ 5 A, ${ m V}_{ m GEN}$ = 10 V, ${ m R}_{ m g}$ = 1 Ω		22	33	
Fall Time	t _f			6	10	
Turn-On Delay Time	t _{d(on)}			16	24	
Rise Time	t _r	V_{DD} = 50 V, R_L = 10 Ω		12	18	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 5 \text{ A}, \text{ V}_{\text{GEN}} = 8 \text{ V}, \text{ R}_g = 1 \Omega$		20	30	
Fall Time	t _f			7	12	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	۱ _S	T _C = 25 °C			7.7	А
Pulse Diode Forward Current ^a	I _{SM}				50	A
Body Diode Voltage	V _{SD}	I _S = 2.6 A		0.77	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			63	95	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$L = 5 \wedge dt/dt = 100 \wedge 4u_0 = 7 + 25 \circ 0$		110	165	nC
Reverse Recovery Fall Time	t _a	$I_F = 5 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, \text{ T}_J = 25 \text{ °C}$		49		
Reverse Recovery Rise Time	t _b			14		ns

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

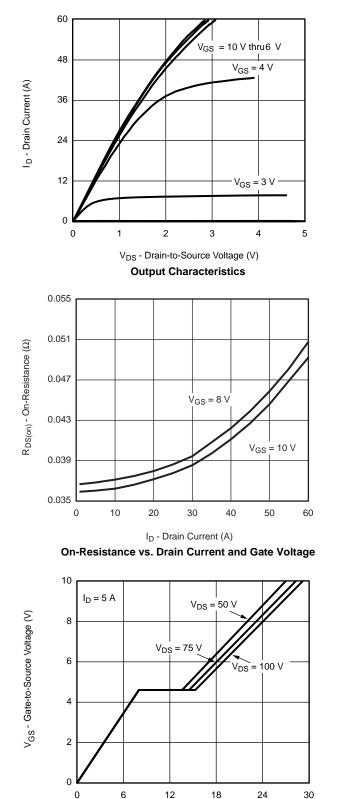
a. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Bsemi

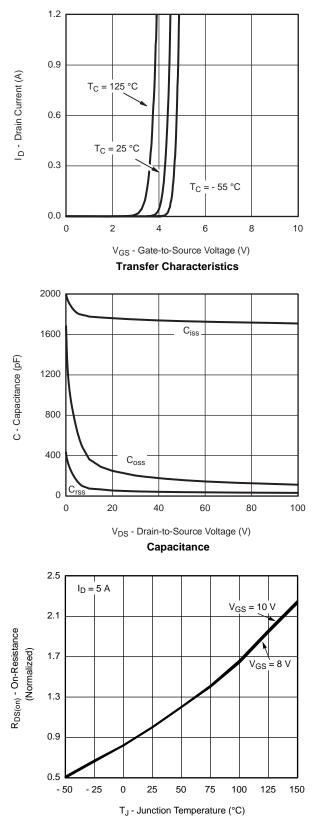
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Q_g - Total Gate Charge (nC) Gate Charge

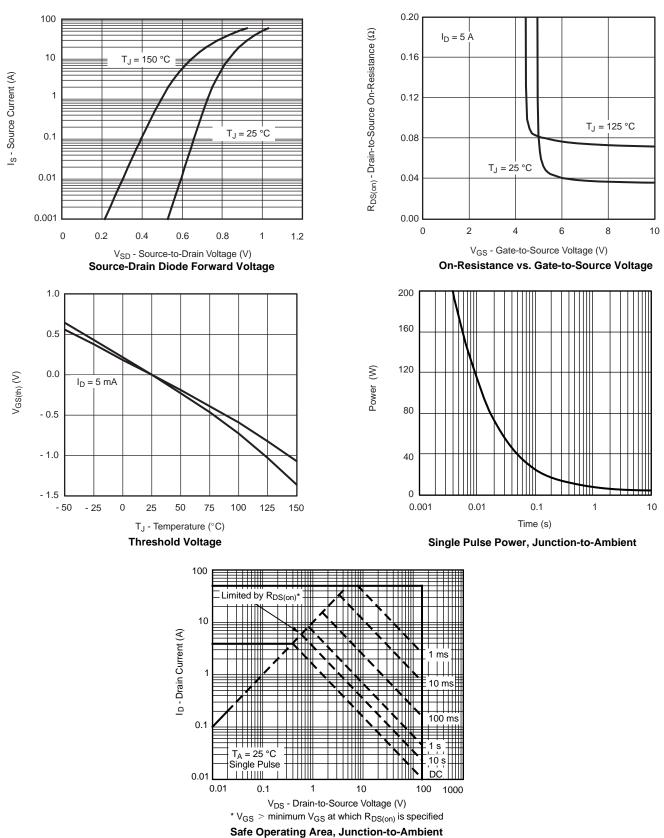
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



On-Resistance vs. Junction Temperature

服务热线:400-655-8788

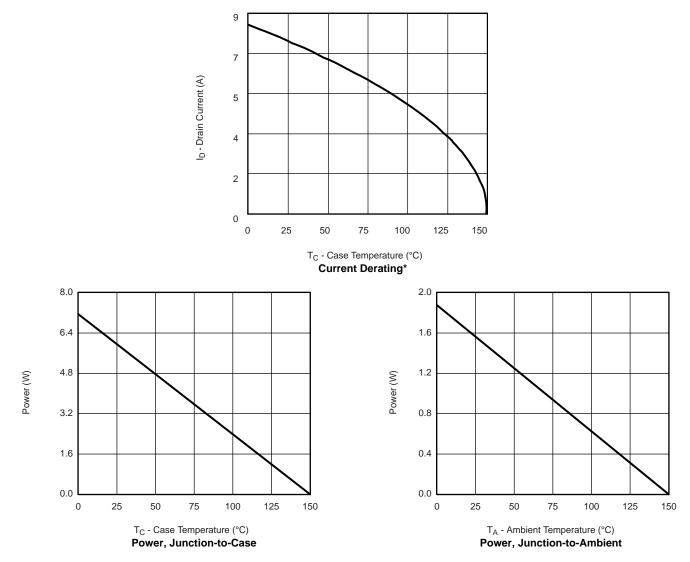




TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



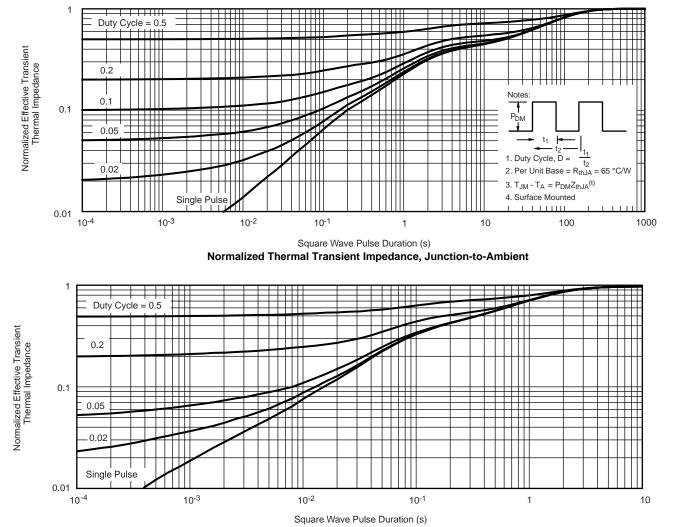
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



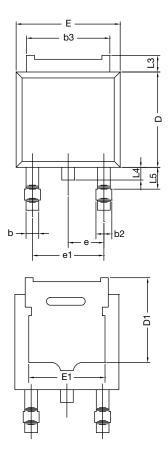
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot



TO-252AA CASE OUTLINE





	MILLIMETERS		INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	2.18	2.38	0.086	0.094	
A1	-	0.127	-	0.005	
b	0.64	0.88	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	
С	0.46	0.61	0.018	0.024	
C2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	
D1	5.21	-	0.205	-	
E	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
Н	9.40	10.41	0.370	0.410	
е	2.28 BSC		0.090 BSC		
e1	4.56 BSC		0.180 BSC		
L	1.40	1.78	0.055	0.070	
L3	0.89	1.27	0.035	0.050	
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	
ECN: X12-0247-Rev. M, 24-Dec-12 DWG: 5347					

Note

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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